High Voltage Switching Diode

The BAS21TMR6T1G device houses three high-voltage switching diodes in a SC-74 surface mount package. This device is ideal for low-power surface mount applications where board space is at a premium.

Features

- Reduces Board Space
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable

MAXIMUM RATINGS (EACH DIODE)

Rating	Symbol	Value	Unit
Reverse Voltage	V _R	250	Vdc
Forward Current	١ _F	200	mAdc
Peak Forward Surge Current	I _{FM(surge)}	625	mAdc

THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Total Device Dissipation FR–5 Board (Note 1) T _A = 25°C Derate above 25°C	PD	311 2.5	mW mW/°C
Thermal Resistance, Junction-to-Ambient	R _{θJA}	402	°C/W
Total Device Dissipation Alumina Substrate, (Note 2) T _A = 25°C Derate above 25°C	PD	347 2.8	mW mW/°C
Thermal Resistance, Junction-to-Ambient	R _{θJA}	360	°C/W
Junction and Storage Temperature	T _J , T _{stg}	– 55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

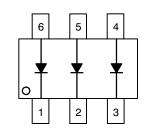
1. FR-4 @ 10 mm², 2 oz copper traces 2. FR-4 @ 25 mm², 2 oz copper traces



ON Semiconductor®

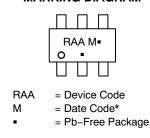
http://onsemi.com

250 V **HIGH VOLTAGE** SWITCHING DIODE





MARKING DIAGRAM



(Note: Microdot may be in either location) *Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
BAS21TMR6T1G	SC-74 (Pb-Free)	3000 / Tape & Reel
NSVBAS21TMR6T1G	SC-74 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
Reverse Voltage Leakage Current	I _R			μAdc
(V _R = 200 Vdc)		-	0.1	
(V _R = 200 Vdc, T _J = 150°C)		-	100	
Reverse Breakdown Voltage (I _{BR} = 100 µAdc)	V _(BR)	250	-	Vdc
Forward Voltage	VF			Vdc
(I _F = 100 mAdc)		-	1.0	
(I _F = 200 mAdc)		-	1.25	
Diode Capacitance (V _R = 0, f = 1.0 MHz)	CD	-	5.0	pF
Reverse Recovery Time ($I_F = I_R = 30$ mAdc, $I_{R(REC)} = 3.0$ mAdc, $R_L = 100$)	t _{rr}	-	50	ns

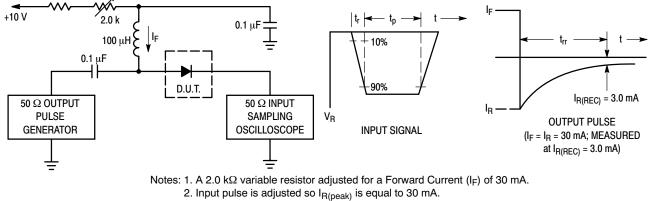
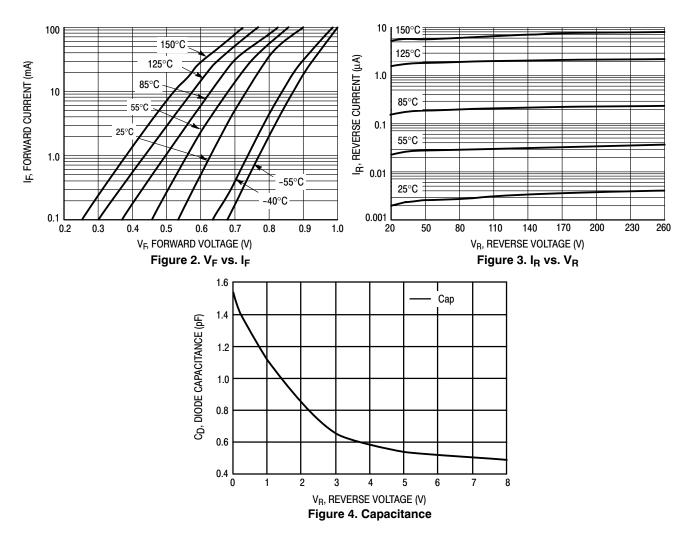




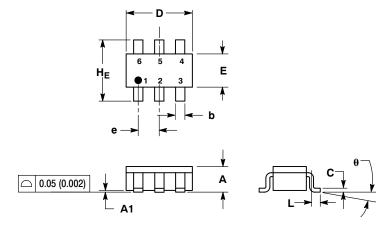


Figure 1. Recovery Time Equivalent Test Circuit



PACKAGE DIMENSIONS

SC-74 CASE 318F-05 ISSUE M

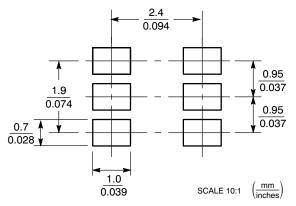


NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: INCH.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS.
- THICKNESS OF BASE MATERIAL. 4. 318F-01, -02, -03 OBSOLETE. NEW STANDARD 318F-04.

N NOM 0 1.00 1 0.06	MAX 1.10 0.10	MIN 0.035	NOM 0.039	MAX 0.043
			0.039	0.043
1 0.06	0.10			0.040
	0.10	0.001	0.002	0.004
5 0.37	0.50	0.010	0.015	0.020
0 0.18	0.26	0.004	0.007	0.010
0 3.00	3.10	0.114	0.118	0.122
0 1.50	1.70	0.051	0.059	0.067
5 0.95	1.05	0.034	0.037	0.041
0 0.40	0.60	0.008	0.016	0.024
0 2.75	3.00	0.099	0.108	0.118
-	10°	0°	-	10°
	0 0.18 0 3.00 0 1.50 5 0.95 0 0.40 0 2.75	0 0.18 0.26 0 3.00 3.10 0 1.50 1.70 5 0.95 1.05 0 0.40 0.60 0 2.75 3.00	0 0.18 0.26 0.004 0 3.00 3.10 0.114 0 1.50 1.70 0.051 5 0.95 1.05 0.034 0 0.40 0.60 0.009 0 2.75 3.00 0.099	0 0.18 0.26 0.004 0.007 0 3.00 3.10 0.114 0.118 0 1.50 1.70 0.051 0.059 5 0.95 1.05 0.034 0.037 0 0.40 0.60 0.008 0.016 0 2.75 3.00 0.099 0.108

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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